

Appl. No. 10/589,092

Request for Corrected Filing Receipt dated April 25, 2007

Attorney Docket No. 1217-062373

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/589,092 Confirmation No. 5485
Applicants : Hiroyuki FUKUYAMA et al.
Filed : August 9, 2006
Title : Metallized Ceramic Molding, Process for Producing the Same and Peltier Device
Art Unit : 1755
Customer No. : 28289

FACSIMILE NO. 703-305-9822

Office of Initial Patent Examination's
Filing Receipt Corrections
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REQUEST FOR CORRECTED FILING RECEIPT

Sir:

Attached is a marked-up copy of the official Filing Receipt for the above-identified patent application for which a Corrected Filing Receipt is hereby requested.

- (1) The third Applicant's name is misspelled in that "SHIGO" should read --SHINGO--
(2) There are two Assignees. "Assignment For Published Patent Application" should read: -- Tokuyama Corporation, Shunan-shi, JAPAN; and

The Circle for the Promotion of Science and Engineering, Meguro-ku, JAPAN--.

Copies of the Declaration and Power of Attorney (see page 3) and Application Data Sheet (see pages 2 and 3) are enclosed for verification.

Respectfully submitted,

THE WEBB LAW FIRM

By




Kent E. Baldauf
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Attorney for Applicants
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FACSIMILE TRANSMISSION

I hereby certify that this correspondence is being facsimile transmitted to the United States Patent and Trademark Office on the date set forth below.

Diane Paull
(Name of Person Mailing Paper)


Signature Date 04/25/2007



UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE
United States Patent and Trademark Office
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APPL NO.	FILING OR 371(c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	TOT CLMS	IND CLMS
10/589,092	08/09/2006	1755	1950	1217-062373	14	7

CONFIRMATION NO. 5485

28289

THE WEBB LAW FIRM, P.C.
700 KOPPERS BUILDING
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FILING RECEIPT



OC00000022860842

Date Mailed: 03/19/2007

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Hiroyuki Fukuyama, Miyagi, JAPAN;
Takehiko Yoneda, Yamaguchi, JAPAN;
Shigo Kikutani, Yamaguchi, JAPAN;

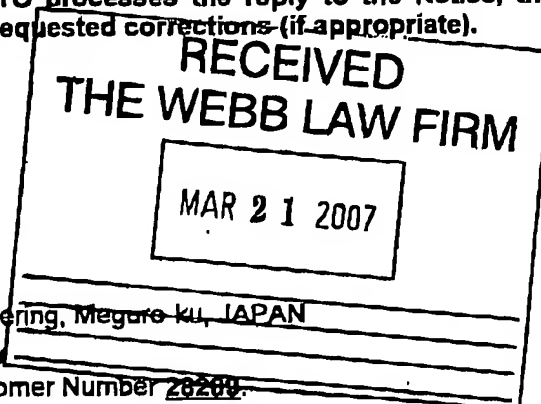
-SHINGO-

Assignment For Published Patent Application

The Circle for the Promotion of Science and Engineering, Meguro-ku, JAPAN

-Tokuyama Corporation, Shunan-shi,
JAPAN--

Power of Attorney: The patent practitioners associated with Customer Number 28289.



Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP05/01786 02/07/2005

Foreign Applications

JAPAN 2004-031627 02/09/2004
JAPAN 2004-034873 02/12/2004

If Required, Foreign Filing License Granted: 03/12/2007

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is **US10/589,092**

Projected Publication Date: 06/21/2007

Non-Publication Request: No

Early Publication Request: No

Title

Metallized ceramic molding, process for producing the same and peltier device

Preliminary Class

501

PROTECTING YOUR INVENTION OUTSIDE THE UNITED STATES

Since the rights granted by a U.S. patent extend only throughout the territory of the United States and have no effect in a foreign country, an inventor who wishes patent protection in another country must apply for a patent in a specific country or in regional patent offices. Applicants may wish to consider the filing of an international application under the Patent Cooperation Treaty (PCT). An international (PCT) application generally has the same effect as a regular national patent application in each PCT-member country. The PCT process **simplifies** the filing of patent applications on the same invention in member countries, but **does not result** in a grant of "an international patent" and does not eliminate the need of applicants to file additional documents and fees in countries where patent protection is desired.

Almost every country has its own patent law, and a person desiring a patent in a particular country must make an application for patent in that country in accordance with its particular laws. Since the laws of many countries differ in various respects from the patent law of the United States, applicants are advised to seek guidance from specific foreign countries to ensure that patent rights are not lost prematurely.

Applicants also are advised that in the case of inventions made in the United States, the Director of the USPTO must issue a license before applicants can apply for a patent in a foreign country. The filing of a U.S. patent application serves as a request for a foreign filing license. The application's filing receipt contains further information and guidance as to the status of applicant's license for foreign filing.

Applicants may wish to consult the USPTO booklet, "General Information Concerning Patents" (specifically, the section entitled "Treaties and Foreign Patents") for more information on timeframes and deadlines for filing foreign patent applications. The guide is available either by contacting the USPTO Contact Center at 800-786-9199, or it can be viewed on the USPTO website at <http://www.uspto.gov/web/offices/pac/doc/general/index.html>.

For information on preventing theft of your intellectual property (patents, trademarks and copyrights), you may wish to consult the U.S. Government website, <http://www.stopfakes.gov>. Part of a Department of Commerce initiative, this website includes self-help "toolkits" giving innovators guidance on how to protect intellectual property in specific countries such as China, Korea and Mexico. For questions regarding patent enforcement issues, applicants may call the U.S. Government hotline at 1-866-999-HALT (1-866-999-4158).

**LICENSE FOR FOREIGN FILING UNDER
Title 35, United States Code, Section 184
Title 37, Code of Federal Regulations, 5.11 & 5.15**

GRANTED

The applicant has been granted a license under 35 U.S.C. 184, if the phrase "IF REQUIRED, FOREIGN FILING LICENSE GRANTED" followed by a date appears on this form. Such licenses are issued in all applications where

Declaration and Power of Attorney for Patent Application

English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled METALLIZED CERAMIC SHAPED ARTICLE, PROCESS FOR PRODUCING THE SAME, AND PELTIER ELEMENT

The specification of which

☐ is attached hereto.

☐ was filed on _____

as Application Serial No. _____

and was amended on _____

(if applicable)

☒ was filed as PCT international application

No. PCI/JP2005/1786

on February 7, 2005

and was amended under PCT Article 19 on _____

(if applicable)

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

Priority Claimed

2004-031627

(Number)

JAPAN

(Country)

09/February/2004

(Day/Month/Year Filed)

☒

Yes

☐

No

2004-034873

(Number)

JAPAN

(Country)

12/February/2004

(Day/Month/Year Filed)

☒

Yes

☐

No

(Number)

(Country)

(Day/Month/Year Filed)

☐

Yes

☐

No

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(W01751741)

(Application Serial No.)

(Filing Date)

(Status)
(patented, pending, abandoned)

(Application Serial No.)

(Filing Date)

(Status)
(patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 100) of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the practitioners associated with

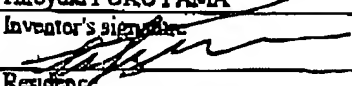
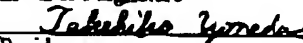
Customer Number 28289

to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith.

Customer Number 28289 identifies the law firm of **WEBB ZIESENHEIM LOGSDON ORKIN AND HANSON, P.C.** whose address is 700 Koppers Building, 436 Seventh Avenue, Pittsburgh, Pennsylvania 15219-1818, Telephone No. 412-471-8815

Please send all correspondence to Customer Number 28289.

Please direct all telephone calls to Kent E. Baldauf, at telephone number (412) 471-8815.

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{WU175174.1}

Page 3

Full name of third joint inventor, if any Shingo KIKUTANI	
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Inventor's signature	Date
Residence	
Citizenship	
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Full name of fifth joint inventor, if any	
Inventor's signature	Date
Residence	
Citizenship	
Post Office Address	
Full name of sixth joint inventor, if any	
Inventor's signature	Date
Residence	
Citizenship	
Post Office Address	

{W0173174.1}

APPLICATION DATA SHEET**APPLICATION INFORMATION**

Application Number::	Not Yet Assigned
Filing Date::	Concurrently Herewith
Application Type::	Regular
Subject Matter::	Utility
CD-ROM or CD-R?::	None
Title::	METALLIZED CERAMIC MOLDING, PROCESS FOR PRODUCING THE SAME AND PELTIER DEVICE
Attorney Docket Number::	1217-062373
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	19
Total Drawing Sheets::	7
Small Entity?::	No
Secrecy Order In Parent Appl.?::	No

APPLICANT INFORMATION

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Postal or Zip Code of Mailing Address::**9808577****Applicant Authority Type::****Inventor****Primary Citizenship Country::****Japan****Status::****Full Capacity****Given Name::****Takehiko****Family Name::****Yoneda****City of Residence::****Shunan-shi****State or Province of Residence::****Yamaguchi****Country of Residence::****Japan****Street of Mailing Address::****c/o Tokuyama Corporation,
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REPRESENTATIVE INFORMATION

Representative Customer Number::	28289	
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FOREIGN PRIORITY INFORMATION

Country::	Application number::	Filing Date::	Priority Claimed::
WO	PCT/JP2005/001786	02/07/05	Yes
JP	2004-031627	02/09/04	Yes
JP	2004-034873	02/12/04	Yes

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